Texas Instruments Inc. (DUNS# 00-732-1904) Supplier Name:

Contact Info:

ti.com/support
Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

Created on: 05/06/2022

Details for "NE5534ADR"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
NE5534ADR	NIPDAU	Level-2-260C-1 YEAR	TI AGUASCALIENTES	D 8	3.91x4.9x1.58	107.8

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB	
Yes	Yes	Yes	Yes	

Component Information

Component	Substance			Homogeneous Material Level		Component Level	
		CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.036413	99.997254	999973	0.033785	33
Precious Metals	Silver	7440-22-4	0.000001	0.002746	27	0.000001	
Sub-Total			0.036414	100	1000000	0.033785	33
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.398091	78.999946	789999	0.369355	369
Thermoplastics	Ероху	85954-11-6	0.105822	21.000054	210001	0.098183	98
Sub-Total			0.503913	100	1000000	0.467538	467
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	40.49388	96.414	964140	37.570845	37570
Copper and Its Alloys	Iron	7439-89-6	1.092	2.6	26000	1.013174	1013
Copper and Its Alloys	Phosphorus	7723-14-0	0.063	0.15	1500	0.058452	58
Nickel and Its Alloys	Nickel	7440-02-0	0.336	0.8	8000	0.311746	31:
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.0042	0.01	100	0.003897	
Precious Metals	Gold	7440-57-5	0.0042	0.01	100	0.003897	
Precious Metals	Palladium	7440-05-3	0.00672	0.016	160	0.006235	-
Sub-Total			42	100	1000000	38.968246	38968
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	3.99504	95.12	951200	3.70666	3706
Precious Metals	Gold	7440-57-5	0.03276	0.78	7800	0.030395	31
Precious Metals	Palladium	7440-05-3	0.1722	4.1	41000	0.15977	159
Sub-Total			4.2	100	1000000	3.896825	3896
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	52.102381	88	880000	48.341391	48343
Other Plastics and Rubber	Carbon Black	1333-86-4	0.177622	0.3	3000	0.1648	164
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	0.32564	0.55	5500	0.302134	30
Thermoplastics	Epoxy	85954-11-6	6.601608	11.149999	111500	6.125073	612
Sub-Total			59.207251	100	1000000	54.933399	5493
Semiconductor Device		•			•		
Ceramics / Glass	Doped Silicon	7440-21-3	1.832484	100	1000000	1.700207	1700
Sub-Total			1.832484	100	1000000	1.700207	1700
•					•	·	
Total			107.780062			100	100000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.

See Glossary of Terms for more details.

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page

Product Content Methodology
For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-Free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is. For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 05/06/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures. TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

ROHS Exempt: Means TI semiconductor products that contain lead (Pb) above the ROHS Annex II threshold, but that fall within one of the specific ROHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.